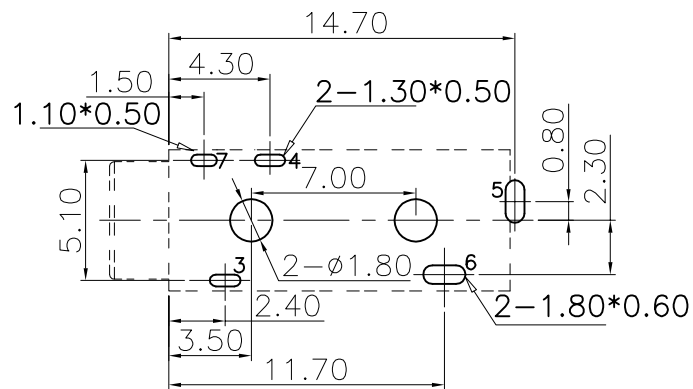
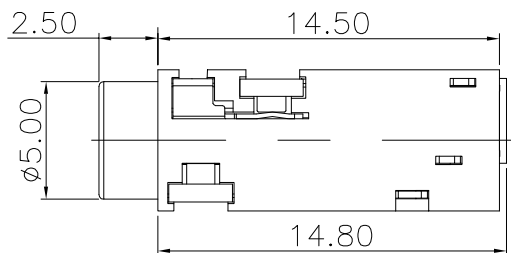
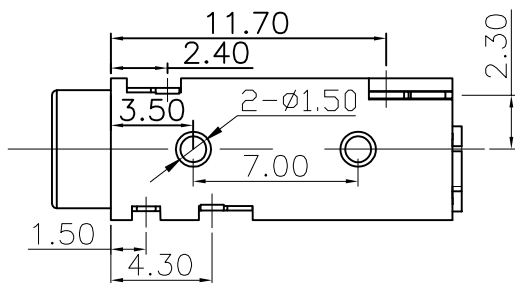
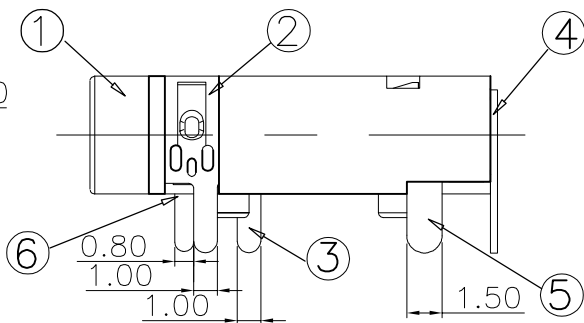
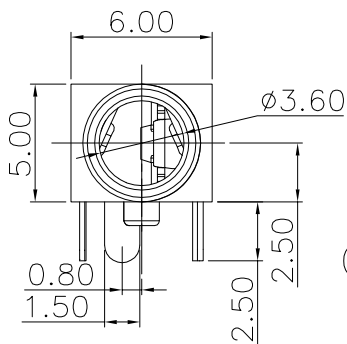


The product using material and processing must conform to the "WL-PZ-001" HSF technical standard control requirements

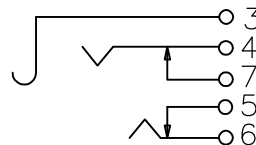
RoHS



PCB LAYOUT
(BOTTOM VIEW)



SCHMATIC



NOTE:

- 1.MATERIAL SPECIFICATION:
 - 1-1.HOUSING:PBT COLOUR:BLACK
 - 1-2.TERMINAL 1:PHOSPHOR BRONZE T=0.25mm
 - 1-3.TERMINAL 2:PHOSPHOR BRONZE T=0.25mm
 - 1-4.TERMINAL 3:BRASS T=0.30mm
 - 1-5.TERMINAL 4:PHOSPHOR BRONZE T=0.30mm
 - 1-6.TERMINAL 5:PHOSPHOR BRONZE T=0.20mm
- 2.PLATING SPECIFICATION:
 - 2-1.TERMINAL 1/2/3/4/5: AG PLATING ON CONTACT AREA.
- 3.MECHANICAL PERFORMANCE:
 - 3-1.EXTRACTION FORCE:3N MIN
 - 3-2.INSERTION FORCE:30N MAX
 - 3-3.LIFE TEST: 3000 CYCLES
- 4.ELECTRICAL PERFORMANCE:
 - 4-1.RATED CURRENT:1A DC
 - 4-2.NOMINAL VOLTAGE:12V DC
 - 4-3.CONTACT RESISTANCE: 30mΩ MAX,
 - 4-4.INSULATION RESISTANCE:100MΩ MIN
 - 4-5.WITHSTANDING VOLTAGE: 500V AC
- 5.OPERATION TEMPERATURE RANGE:-20°C~+85°C
- 6.P/N: WLPJF9-05 X 1 1 0 063

PLATED: 1.G/F
7.SN
8.AG
HOUSING: 1.PBT BLACK

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: WLPJF9-05X110063	DWG.NO: ENDE05		
AO	NEW RELEASE	21.01.13		LINEAR	ANGLES	APPROVED	Wang_jr	21.01.13				
			UNIT:mm	0.00±0.25	X'±3'	DESIGNER	Han_Gao	21.01.13	TITLE: PHONE JACK			REV: A0 SHEET: 1/1
			SIZE: A4	0.000±0.10	X'X' ±2'	DRAWN	Zijun_Huang	21.01.13				